

Customer Information Notification

Issue Date: 04-Mar-2017 Effective Date: 05-Mar-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

2016120421



Change Category

[] Wafer Fab Process [] Assembly[] Product Marking [X] Test [] Design Process Location [] Wafer Fab Materials [] Assembly[] Mechanical [] Test [] Errata Materials Specification Process [] Wafer Fab Location [] Assembly[] [] Test [] Electrical

[] Assembly[] [] Test [] Electrical Location Packing/Shipping/Labeling Equipment spec./Test coverage

MPC5744P 144LQFP Test Site Expansion from NXP-ATKL to KES-Malaysia

Information Notification

NXP Semiconductor is announcing the test site expansion for the Part Number MPC5744P from the current NXP-ATKL Malaysia Final Test Facility to the KES Malaysia Final Test Facility.

Why do we issue this Information Notification

Qualification of the KES Malaysia Test Facility to ensure manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Additional information

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Rudy Mazlan
Position Product Engineer
e-mail address rudy.mazlan@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

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Affected Part Numbers

SPC5744PFK1AMLQ9 SPC5744PFK1AMLQ9 SPC5744PFK1AMLQ9